Edge and Data Center Cooling Solutions

Precision and High Density Liquid Cooling

CONNECT AND PROTECT

CADDY  ERICO  HOFFMAN  RAYCHEM  SCHROFF  TRACER
**Edge And Data Center Cooling Solutions**

*Increasing heat densities challenge data center operators and the demand for reduced data latency requires more computing power at the edge.*

Content streaming, online banking, cloud computing, sophisticated smart phone apps, eCommerce, industrial automation. These are just a few examples of applications that are fueling data processing and traffic demand in data centers throughout the world. Emerging technologies, such as Artificial Intelligence (AI), telemedicine, machine learning, autonomous (driverless) vehicles and other real-time modeling applications will accelerate demand further.

**Data Center Cooling Solutions**

Maintaining high availability (uptime) at minimal operational costs remains a major challenge in today's data centers and networks. A significant portion of budgets includes energy consumption for IT equipment and server cooling.

nVent offers a comprehensive range of standard and customized air, indirect and direct water cooling solutions. Our product range enables you to meet these challenges and protect your IT assets, whether for smaller decentralized edge computing, harsh environments, or large data center installations.

**Edge Computing Cooling Solutions**

The rapid emergence of Big Data, 5G, Industry 4.0 and IoT deployments also require protection for edge-computing applications, such as high-speed wireless, autonomous vehicles, industrial automation, transportation, security, and safety systems. These complex systems are powered by smaller and faster electronics that require effective cooling protection to ensure maximum operating performance and uptime.

**Maximize Infrastructure Performance And Uptime**

Legacy cooling in data centers uses technology based on traditional air conditioning systems. Entire rooms, sometimes complete buildings, are cooled with a single system. These Computer Room Air Conditioning units (CRAC) or Computer Room Air Handler (CRAH) worked well for a number of years because data rooms were smaller, IT cabinets were not densely packed, and less heat was generated in a given space. While still popular today, whole room cooling can be inefficient and expensive.

**COMPLETE PORTFOLIO AIR AND LIQUID COOLING SOLUTIONS**

- **2-8 kW**
  - Server Rack w/Fans or AC
  - Rack w/low capacity Air-To-Liquid HX

- **8-10 kW**
  - Rack w/medium capacity Air-To-Liquid HX

- **15-25 kW**
  - Rack w/high capacity Air-To-Liquid HX
  - Aisle Containment (Hot and Cold)

- **40-105 kW**
  - *Row Coolant Distribution Unit*

- **25-60 kW**
  - Rack/Row Liquid-to-Air (Rear Door/Side Car)

- **>25 kW Per Rack**
  - *Direct-to-Chip and Immersion Cooling Rack Manifolds*

- **15 kW Per Rack**
  - Rear Door Cooling (Passive/Active)
Wall-Mount Solutions

**Features**
- Thermostat control and EMU/RFI noise suppressor included
- Closed-loop cooling separates clean, recirculated air from ambient airflow system
- Front cover hinges open for quick access to all components
- Filter can be inverted to double operating time between cleanings and/or filter replacement
- Filterless operation possible in many applications
- All units use a universally accepted CFC-free or environmentally safe refrigerant
- Clean, recirculated air is kept separate from the ambient airflow. This protects the electronic controls and prevents shutdowns caused by heat, humidity, dust and other contaminants.

**Closed Loop Cooling**
Recirculated air inside the air conditioner is kept separate from the ambient airflow system. This protects the electronic controls and prevents shutdowns caused by heat, humidity, dust and other contaminants.

**Free-standing Cabinets And Outdoor Solutions**

**SpectraCool Compact Indoor (N21)**

<table>
<thead>
<tr>
<th>Indoor Model</th>
<th>N21056G050</th>
<th>N21056G060</th>
</tr>
</thead>
<tbody>
<tr>
<td>BTU/Hr.</td>
<td>235/235</td>
<td>248/248</td>
</tr>
<tr>
<td>Watts</td>
<td>816/851</td>
<td>840/876</td>
</tr>
<tr>
<td>CFM</td>
<td>240/240</td>
<td>278/278</td>
</tr>
<tr>
<td>Height</td>
<td>22</td>
<td>22</td>
</tr>
<tr>
<td>Width</td>
<td>24</td>
<td>24</td>
</tr>
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</table>

**SpectraCool Narrow Indoor/Outdoor (N28)**

<table>
<thead>
<tr>
<th>Outdoor Model without Heat Pkg.</th>
<th>N280416G151</th>
</tr>
</thead>
<tbody>
<tr>
<td>BTU/Hr.</td>
<td>3800/4000</td>
</tr>
<tr>
<td>Watts</td>
<td>1114/1172</td>
</tr>
<tr>
<td>CFM</td>
<td>3754/4011</td>
</tr>
<tr>
<td>Height</td>
<td>36</td>
</tr>
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<td>Width</td>
<td>18</td>
</tr>
</tbody>
</table>

**SpectraCool Indoor/Outdoor (G52)**

<table>
<thead>
<tr>
<th>Outdoor Model without Heat Pkg.</th>
<th>G520816G100</th>
</tr>
</thead>
<tbody>
<tr>
<td>BTU/Hr.</td>
<td>6000/6800</td>
</tr>
<tr>
<td>Watts</td>
<td>2139/2403</td>
</tr>
<tr>
<td>CFM</td>
<td>2578/2871</td>
</tr>
<tr>
<td>Height</td>
<td>33</td>
</tr>
<tr>
<td>Width</td>
<td>18</td>
</tr>
</tbody>
</table>

**For Decentralized IT and Communication**

The Varistar LHX+ electronic cabinet including air/water heat exchanger with 5 kW or 10 kW cooling capacity is well-suited for applications where a fully sealed cabinet is required.

**Cooling**
- **Concept:** 19-inch heat exchanger (6 U) installed in lower cabinet section
- **Scalable cooling performance**
  - Double fan unit for 10 kW cooling performance
  - Single fan unit for 5 kW cooling performance
- **Space-saving:** Available starting at 600W x 800D base area per cabinet
- **Precision control:** With precise temperature regulation accuracy of +/- 0.1°C
- **Greater productivity, higher safety:** Heat exchanger control directly at the cabinet via the display on the door. Remote access control with EtherCAT, Ethernet/IP Modbus, or Profinet is also possible. Web server access optional.

**Applications**
- **Indoor/Outdoor Air Conditioners**
  - Handbooks furnished
  - Safe refrigerant
  - Full cooling capacity
  - Moisture from enclosure is kept separate from the ambient airflow system
  - Separate, recirculated air from ambient airflow system
  - Hot-swap applicable:
    - EC fans with speed control can be maintained without tools and even replaced in ongoing operation
  - **Space-saving:** Available starting at 600W x 800D base area per cabinet
  - **Precision control:** With precise temperature regulation accuracy of +/- 0.1°C
  - **Greater productivity, higher safety:** Heat exchanger control directly at the cabinet via the display on the door. Remote access control with EtherCAT, Ethernet/IP Modbus, or Profinet is also possible. Web server access optional.

**ORDER INFORMATION**

<table>
<thead>
<tr>
<th>DESCRIPTION</th>
<th>MODEL NUMBER</th>
</tr>
</thead>
<tbody>
<tr>
<td>Complete solution (heat exchanger and cabinet)</td>
<td>10130-325</td>
</tr>
<tr>
<td>Usable assembly height 35 U</td>
<td>10130-326</td>
</tr>
<tr>
<td>10 kW heat exchanger with two 230-V fans</td>
<td>29714-016</td>
</tr>
<tr>
<td>5 kW heat exchanger with one 230-V fan</td>
<td>29714-017</td>
</tr>
<tr>
<td>Control kit</td>
<td>23130-664</td>
</tr>
<tr>
<td>Flow rate and water T° sensor kit</td>
<td>23130-663</td>
</tr>
<tr>
<td>Display and accessories for LHX+</td>
<td>23130-666</td>
</tr>
<tr>
<td>Door contact switch kit</td>
<td>23130-667</td>
</tr>
</tbody>
</table>

**COOLING**
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Data Center Cooling Strategies

Localized Row And Cabinet Level Cooling Methodologies

Room cooling can be inefficient and expensive. Four approaches for dissipating IT equipment heat loads include:

- Air cooled: heat is transferred directly to the room air and cooled via traditional data center cooling
- Indirect water-cooled: heat is transferred indirectly to water through an air-to-water heat exchanger located within the row or single cabinet
- Direct water-cooled: heat is transferred directly to an attached heat transfer component, such as a cold plate
- Hybrid direct and indirect water-cooled - selective cooling of highest energy-consuming components with direct contact liquid cooling and the balance of the cabinet is cooled via secondary air-to-water cooling device, such as a Rear Door Cooler (RDC).

To maintain maximum IT equipment (ITE) availability, all equipment must be kept below a specified temperature range—a requirement that has recently become more challenging to meet. As the need for information has increased, so has the processing power of the network equipment, resulting in increasingly higher processor densities and heat levels. Elevated temperatures result in equipment failure, and ultimately, costly downtime, making the need for efficient cooling systems more important than ever. Since nearly all power consumed by the processors is converted to heat—which must be removed via air (convection)—the data center in which this equipment resides must efficiently provide cold air to network equipment intakes and recycle the hot exhaust to remove the heat and keep vital networking equipment operating.

### Data Center Strategies - Cooling

<table>
<thead>
<tr>
<th>Strategy</th>
<th>Approach</th>
<th>Capital costs/kW</th>
<th>Operating costs/kW</th>
<th>Average max kW per cabinet</th>
<th>Reliability (Complexity)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Random (chaos)</td>
<td>Yes</td>
<td>$</td>
<td>$</td>
<td>$</td>
<td>$</td>
</tr>
<tr>
<td>Hot aisle / cold aisle</td>
<td>Yes</td>
<td>$</td>
<td>$</td>
<td>$</td>
<td>$</td>
</tr>
<tr>
<td>Containment (raised floor)</td>
<td>Room based</td>
<td>Yes</td>
<td>$</td>
<td>$</td>
<td>$</td>
</tr>
<tr>
<td>Chimney</td>
<td>Yes or No</td>
<td>$</td>
<td>$</td>
<td>$</td>
<td>$</td>
</tr>
<tr>
<td>Closed-loop, ducting, hot and cold containment</td>
<td>Yes or No</td>
<td>$</td>
<td>$</td>
<td>$</td>
<td>$</td>
</tr>
<tr>
<td>In-row cooling &amp; containment (heat exchanger)</td>
<td>Row based</td>
<td>No</td>
<td>$</td>
<td>$</td>
<td>$</td>
</tr>
<tr>
<td>In-Rack &amp; Rear Door liquid cooling (heat exchanger)</td>
<td>Rack based</td>
<td>No</td>
<td>$</td>
<td>$</td>
<td>$</td>
</tr>
<tr>
<td>Chip-level liquid cooling</td>
<td>Chip based</td>
<td>No</td>
<td>$</td>
<td>$</td>
<td>$</td>
</tr>
</tbody>
</table>

Localized cooling improves efficiency and reliability while reducing the risk of equipment failures.
Aisle Containment

**Improved Air Management Helps To Reduce Energy Costs**

The use of containment systems can dramatically reduce energy costs, minimize hot spots and improve the carbon footprint of the data center. Both hot aisle containment (HAC) and cold aisle containment (CAC) systems greatly improve the data center cooling efficiency by segregating cold and hot airstreams and preventing them from intermixing. The basic design principle is to enclose the hot or cold aisle through the use of aisle-way doors, roof or baffle panels, and internal sealing within the cabinets. nVent offers tailored modular aisle containment solutions that include containment doors, aisle top covers, cladding elements and halogen-free gaskets.

**Benefits**

- Consistent separation of cold and hot air
- Enables optimized aisle airflow and temperature
- Low investment with short ROI – minimal maintenance costs
- Short implementation time with minimum investment
- Varistar or Proline sealed containment for maximum efficiency
- Proline Express containment for highest modularity and minimized installation cost

**Containment systems allow for higher cold temperatures per ASHRAE and ΔT, optimizing cooling systems and contributing to reduced energy costs.**

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### Containment Systems

*Proline Express Rack Top Baffles*

The Rack Top Baffles are suitable for most standard width cabinets with solid, perforated or semi-solid steel tops. These attachment mounts allow a high degree of flexibility across the top of the cabinet to work around obstructions. The baffles prevent hot exhaust air from wrapping over the tops of racks. The angular baffle is designed for cold aisle application, vertical baffle hot aisles. However, the components are reconfigurable to allow for both angular or vertical installation.

**Proline Quick Containment**

**Quick and Installation and Reconfiguration**

The Proline Express containment is a set of predefined standard components optimized for easy installation using magnetic fixtures. Its conception minimizes the upfront planning effort, the components are designed such that there is no need for customization to the specific requirements of the facility. The containment assembly is done very fast as no screws are used. This also facilitates the reconfiguration of the containment in case of floor plan changes. This makes it a perfect fit for both retrofit solutions and new installations.

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### Proline Express Sealed Doors and Transom Windows

**FEATURES**

- Designed for 48-inch (1200 mm) wide aisles, but can also provide benefits for wider aisles
- The Bi-directional doors require a minimum 6-inch (152 mm) clearance from the front edge of the cabinet along its entire height for the hinges to attach
- Works with a variety of cabinets 76-inch (1930 mm) and taller
- Doors can be installed to hot or cold aisle
- Doors attached to side of rack magnetically

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### Table

<table>
<thead>
<tr>
<th>Cabinet With Chimney Vertical Exhaust System</th>
<th>Cold Aisle Containment</th>
</tr>
</thead>
<tbody>
<tr>
<td>Heat radiation</td>
<td>No mixing of warm and cold air</td>
</tr>
<tr>
<td>Top covers and side panels are getting hot and heat up the room. CRAC has to compensate for this under certain conditions</td>
<td></td>
</tr>
<tr>
<td>No mixing of warm and cold air</td>
<td></td>
</tr>
<tr>
<td>Top covers and side panels are getting hot and heat up the room. CRAC has to compensate for this under certain conditions</td>
<td></td>
</tr>
<tr>
<td>No mixing of warm and cold air</td>
<td></td>
</tr>
<tr>
<td>Raised floor/ false ceiling</td>
<td></td>
</tr>
<tr>
<td>Sometimes requires extremely complex planning of arrangement in false ceiling and raised floor remain</td>
<td></td>
</tr>
<tr>
<td>Either raised floor or false ceiling not necessarily required</td>
<td></td>
</tr>
<tr>
<td>Noise</td>
<td>Noise level is reduced due to full metal doors at the back of the cabinet. On the other hand, noise level may increase with the high air velocity of 5m/s within the chimneys</td>
</tr>
<tr>
<td>The server fans are creating the noise, mostly located in the rear side of the chassis. As the rear doors are open, noise level is increased</td>
<td></td>
</tr>
<tr>
<td>Room layout</td>
<td>Location in the room is limited as air ducts, building conditions (cross-ties), electrical cable assembly and CRAC have to be considered</td>
</tr>
<tr>
<td>Free location in the room within the constraints of the cold aisle are possible</td>
<td></td>
</tr>
<tr>
<td>Influence of external ambient</td>
<td>Temperature delta between (cooled) room and external ambient temperature is smaller</td>
</tr>
<tr>
<td>Temperature delta between (warm) room and outside ambient temperature is higher as server exhaust air into the room</td>
<td></td>
</tr>
<tr>
<td>Investment</td>
<td>Low initial investment, no operational costs, no points of failure</td>
</tr>
<tr>
<td>Low initial investment, no operational costs, no points of failure</td>
<td></td>
</tr>
</tbody>
</table>
Row Level Air-to-Liquid Cooling

RackChiller In-Row Precision Cooler
nVent SCHROFF RackChiller In-Row chilled water heat exchanger is a modular and scalable precision cooling solution that can replace or supplement traditional data center cooling infrastructure. The RackChiller In-Row is designed to deliver localized energy efficient cooling, which includes an air-to-water heat exchanger that removes and transfers heat to a water circuit. Six integrated Electronic Commutator (EC) fans provide chilled return air to the front of the unit for localized feed to a contained row and/or adjacent IT equipment.

Features
- Water connection from above or below
- Built-in redundancy through EC fan technology
- Dual A-B power feed (integrated ATS)
- Control with internal and external sensors possible
- Monitoring via SNMP or Modbus
- Monitoring via SNMP or Modbus
- Control with internal and external sensors possible
- Available in 300 mm and 600 mm widths

Benefits
- Up to 85% efficiency improvement vs. CRAC based systems in optimal operating conditions
- Operates with cooling water temperatures up to 84°F / 29°C while maintaining air temperatures within ASHRAE A1 allowable envelope
- Minimal planning outlay; short setup time
- Conforms to UL STD No. 61010-1 and CSA STD C22.2 No. 61010-1
- Conforms to UL STD No. 61010-1 and CSA STD C22.2 No. 61010-1
- Conforms to UL STD No. 61010-1 and CSA STD C22.2 No. 61010-1
- Conforms to UL STD No. 61010-1 and CSA STD C22.2 No. 61010-1

Row Level Cooling Configurations

Open Aisle
Open aisle row configuration includes a single row or dual row of cabinets that separate open cold and hot aisle, no aisle containment. The nVent SCHROFF RackChiller draws hot air from the rear of the cabinets in the hot aisle, removes the heat through an air-to-water heat exchanger and supplies cooled air to the front of IT equipment in the cold aisle.

To increase efficiency it is always better to combine in row cooling with a containment system to minimize air leakage.

Hot Aisle Contained Row
Hot aisle contained row configuration contains the hot exhaust air generated from IT equipment to prevent mixing with cool air in the room environment. The nVent RackChiller draws the contained hot air from the hot aisle, removes the heat through an air-to-water heat exchanger, and feeds cooled air to the front of IT equipment in the uncontained cold aisle.

Cold Aisle Contained Row
Cold aisle contained row configuration contains chilled air provided by the nVent SCHROFF RackChiller in the cold aisle to prevent mixing with hot air generated by the exhaust of equipment within the hot aisle. The nVent RackChiller draws the contained hot air from the hot aisle, removes the heat through an air-to-water heat exchanger, and feeds cooled air to the front of IT equipment in the contained cold aisle.

RackChiller In-Row Technical Data

<table>
<thead>
<tr>
<th>RackChiller In-Row</th>
<th>200 mm wide</th>
<th>600 mm wide</th>
</tr>
</thead>
<tbody>
<tr>
<td>Depth</td>
<td>1200 mm</td>
<td>1200 mm</td>
</tr>
<tr>
<td>Color</td>
<td>Black (RAL 9005), other colors on request</td>
<td></td>
</tr>
<tr>
<td>Weight dry</td>
<td>352 lb/160 kg</td>
<td>421 lb/200 kg</td>
</tr>
<tr>
<td>Supply voltage [VAC]</td>
<td>Dual A-B power feed: 208-230 V</td>
<td></td>
</tr>
<tr>
<td>Input power</td>
<td>Phase to phase or phase to neutral supply</td>
<td></td>
</tr>
<tr>
<td>Connection</td>
<td>Water connection at back, top or bottom</td>
<td></td>
</tr>
<tr>
<td>Pipe connection</td>
<td>1720 mm</td>
<td></td>
</tr>
<tr>
<td>Coolant flow control</td>
<td>Included valve and actuator</td>
<td></td>
</tr>
<tr>
<td>Water valve</td>
<td>2-way (standard), 3-way (optional)</td>
<td></td>
</tr>
<tr>
<td>Volume capacity</td>
<td>2.9 gallons/11 liters</td>
<td>3.1 gallons/11.8 liters</td>
</tr>
<tr>
<td>Fans</td>
<td>Backward curved centrifugal fans incorporating EC technology</td>
<td></td>
</tr>
<tr>
<td>Max. airflow volume [m³/hr]</td>
<td>494.4 cm³/840 m³/hr</td>
<td></td>
</tr>
<tr>
<td>Number of fans</td>
<td>6</td>
<td></td>
</tr>
<tr>
<td>Acoustic emission at 100% fan speed</td>
<td>46 dBA</td>
<td></td>
</tr>
<tr>
<td>Communication protocol</td>
<td>Modbus TCP/IP, SNMP</td>
<td></td>
</tr>
<tr>
<td>Cooling capacity</td>
<td>55kW</td>
<td>75kW</td>
</tr>
<tr>
<td>Cold air temperature</td>
<td>72.7-95°F/22-35°C</td>
<td></td>
</tr>
<tr>
<td>Water supply</td>
<td>57°F/14°C</td>
<td></td>
</tr>
<tr>
<td>Fan airflow</td>
<td>494.4 cm³/840 m³/hr (100%)</td>
<td></td>
</tr>
<tr>
<td>Fluid flow</td>
<td>22.5 gpm/4.6 m³/hr</td>
<td></td>
</tr>
<tr>
<td>Pressure drop</td>
<td>17.7 psig/155 kPA</td>
<td>3.5 psig/27 kPA</td>
</tr>
</tbody>
</table>

Monitoring
- Valve position (adjustable via cold air temperature)
- Fan speed (adjustable via hot air temperature)
- Return water temperature
- Fan function display

Standard Product

<table>
<thead>
<tr>
<th>Part No.</th>
<th>Height x Width x Depth mm</th>
<th>Height x Width x Depth in.</th>
<th>Input Voltage</th>
</tr>
</thead>
<tbody>
<tr>
<td>60714079</td>
<td>2000 x 300 x 1200</td>
<td>78.74 x 11.81 x 47.24</td>
<td>230V phase to neutral</td>
</tr>
<tr>
<td>60714080</td>
<td>2000 x 600 x 1200</td>
<td>78.74 x 23.62 x 47.24</td>
<td>230V phase to neutral</td>
</tr>
<tr>
<td>60714081</td>
<td>2000 x 300 x 1200</td>
<td>78.74 x 11.81 x 47.24</td>
<td>208V phase to phase</td>
</tr>
<tr>
<td>60714082</td>
<td>2000 x 600 x 1200</td>
<td>78.74 x 23.62 x 47.24</td>
<td>208V phase to phase</td>
</tr>
</tbody>
</table>

RackChiller In-Row Accessories

<table>
<thead>
<tr>
<th>Part No.</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>60714083</td>
<td>Hose kit 3/4x25MM</td>
</tr>
<tr>
<td>60714084</td>
<td>Flow control valve</td>
</tr>
<tr>
<td>60714085</td>
<td>Controller nVent</td>
</tr>
<tr>
<td>20714007</td>
<td>Ganging and blanking kit - ProLine, 45U, 300mm</td>
</tr>
<tr>
<td>20714008</td>
<td>Ganging and blanking kit - ProLine, 45U, 600mm</td>
</tr>
<tr>
<td>20714009</td>
<td>Ganging and blanking kit - ProLine, 5U, 300mm</td>
</tr>
<tr>
<td>20714010</td>
<td>Ganging and blanking kit - ProLine, 5U, 600mm</td>
</tr>
<tr>
<td>21138594</td>
<td>Aisle containment adapter kit - top cover mount</td>
</tr>
</tbody>
</table>
RackChiller Rear Door Precision Cooler

nVent SCHROFF RackChiller Rear Door chilled water heat exchanger is designed for managing high heat load cooling requirements within higher-density server, computing and storage racks. The entire system is integrated within an aesthetically framed perforated door with protective covers to isolate the liquid source and cooling loop from the rack-mounted equipment. The RDC installs on equipment racks as a separate complete rear door, enabling it to be retrofitted to existing racks. nVent SCHROFF Rack Door chilled water heat exchanger cools the warm exhaust air generated by the fans in the existing rack-mounted IT equipment through a large cooling coil surface before reintroducing back to the room.

Features
- Passive solution without fans - no noise, no additional power consumption, low maintenance requirements
- Active solution with fans supporting the air flow and minimize pressure drop of the heat exchanger
- Optional water control kit allows water flow regulation according the actual heat load
- Frame solution allows separation of coil and condensate management from the rack mount equipment
- Rear space inside the cabinet is completely available for cabling and power distribution from the rack mount equipment
- Available in 600 mm and 800 mm width in 2,000 mm (42RU), 2,200 mm (47RU) and 2,450 mm (52RU) height
- Easily adapts to nVent cabinets; retrofit kits available for third party cabinets

Benefits
- Modular standard design - easy to adapt to your requirements
- Minimal planning outlay, short setup time
- Versatile infrastructure solutions and product combinations

Passive
The passive RackChiller consists of a mounting frame and a perforated door with integrated heat exchanger. The overall depth is approx. 225 mm.

Active
The active RackChiller consists of a mounting frame and a perforated door with 4 fans and an integrated heat exchanger. The overall depth is approx. 335 mm.

The nVent SCHROFF Rear Door Cooler (RackChiller) is an air-to-water heat exchanger that can be mounted in place of the rear door of a server cabinet.

RackChiller Rear Door Technical Data

<table>
<thead>
<tr>
<th>Part No.</th>
<th>For cabinet [mm]</th>
<th>Width (A) [mm]</th>
<th>Height (B) [mm]</th>
<th>Depth (C) [mm]</th>
<th>Weight (Dry) [kg]</th>
<th>Weight (W) packaging [kg]</th>
<th>Water capacity [l]</th>
<th>Cooling capacity [kW]</th>
<th>Airflow [m³/h]</th>
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<td>138</td>
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</tbody>
</table>

Electrical rating

**RackChiller Passive**
- Input voltage: 200 - 240 VAC, 50/60 Hz
- Input current rated: 180 mA
- Input current max.: 456 mA

**RackChiller Active**
- Input voltage: 200 - 240 VAC, 50/60 Hz
- Input current rated: 2.3 A (238 V)
- Input current max.: 6 A (200 V)

Power consumption:
- Power consumption max.: 125 W
- Input current max.: 6 A (200 V)

Cooling Performance 2000x800mm Rear Door Cooler

**Maximum Air Flow (RackChiller Active)**
- 4,800 m³/h for 800mm wide units
- 5,900 m³/h for 600mm wide units

<table>
<thead>
<tr>
<th>Part No.</th>
<th>For cabinet [mm]</th>
<th>Width (A) [mm]</th>
<th>Height (B) [mm]</th>
<th>Depth (C) [mm]</th>
<th>Weight (Dry) [kg]</th>
<th>Weight (W) packaging [kg]</th>
<th>Water capacity [l]</th>
<th>Cooling capacity [kW]</th>
<th>Airflow [m³/h]</th>
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<td>333</td>
<td>136.9</td>
<td>217</td>
<td>10</td>
<td>50</td>
</tr>
</tbody>
</table>

**Cooling Capacity**

The cooling capacity is determined under the following conditions:
- Ap: water = 100 kPa, Ap air = 15 Pa
- Water flow temperature: 12°C / 53.6°F
- Outlet temperature: 24°C / 75.2°F
- Water flow: 4.8 m³/h / 21.1 gal/min

Accessories RackChiller Rear Door

- Control unit (RackChiller without fans)
- Display for control unit (RackChiller without fans)
- Water connection set, PU 1 kit
- Control valve with servomotor, PU 1 kit
- Control unit (RackChiller without fans), PU 1 kit
High Density Liquid Cooling (HDLC)

Direct Water Cooling Solutions
- Typically reduces energy consumption and operating costs
- Superior cooling capacity
- Acoustic sound abatement
- Liquid cooling eliminates thermal stratification, which occurs as cold air settles at the bottom of the cabinet and hot air moves towards the top, allowing for increased air intake temperatures up to 80°F—further reducing energy needs
- Functions in non-raised floor environments—either by including the piping in the slab floor or installing it in a plinth base under the cabinet
- Clustering high density heat loads into liquid cooled cabinets frees up floor space within the data center
- Higher chilled water temperatures avoid humidification issues, which decrease efficiency and increase energy costs

Features
- ASHRAE W4 warm direct liquid cooling
- 700kW+ cooling capacity
- Direct-to-chip & manifold connectivity
- Smart monitoring & control interface
- Integrated leak detection
- Redundant centralized pumps

Coolant Distribution Network
- Rack-mounted manifolds and hose kits
- Material - copper and stainless steel
- Joints - brazing, welding mechanical couples
- Dripless quick connectors

Experience and Capabilities
- 10+ years liquid cooling experience
- Specialized in custom Coolant Distribution Unit (CDU) design
- Thermal modeling & analysis
- System design & manufacturing
- Leak testing & quality control

With respect to its volume, water has a 3,500 times higher heat capacity versus air

Specifying Liquid Cooling Systems
The major sub-assemblies within a high density liquid-cooled system are typically specific to unique product designs — such as the control system, cold plates, manifolds, arrangement of piping, pumps, valves, etc. Additional common cooling system components and subsystems include quick connects, hoses and connections.
- Heat load
- Secondary return water temperature and secondary flow rate
- Primary (facility) water supply temperature and flow rate
- Secondary pressure drop
- Approach temperature
- Allowable max power consumption
- Form factor / dimensional constraints
- Voltage
- Controls/communication
- Agency approvals

Example High-Density Liquid Cooled (HDLC) System

In this example, the CDU separates the facility water, or primary side, from the much more tightly controlled secondary side water, which flows to the network of liquid cooled servers. Pumps within the CDU circulate the secondary water through the server cold plates and back to the CDU’s heat exchanger, which transfers heat from the secondary loop into the facility water, without the two fluids ever touching.
The nVent HOFFMAN RackChiller CDU40 is a rack-based Coolant Distribution Unit, built for the needs of today’s demanding HPC requirements. The unit is capable of managing 40kW+ of heat load in small 4U of space. The RackChiller CDU40 is a highly efficient heat exchanger that uses ASHRAE W4 warm water to manage processor and component heat. It offers N+1 redundant pump design to provide safe supply of liquid coolant to the IT.

Benefits
- Enables up to 40 kW of liquid heat load in a single rack
- High degree of safety through N+1 pump design
- Best fit for small installations or when high modularity is required

The nVent HOFFMAN RackChiller CDU100 is a rack-based CDU, built for the needs of today’s most demanding HPC requirements. Capable of managing 100kW+ of heat load in a remarkably small 4U of space. The RackChiller CDU100 is an extremely efficient heat exchanger that uses ASHRAE W4 warm water to manage processor and component heat. There are two versions available,

Benefits
- Enables up to 100 kW of liquid heat load in a single rack
- High degree of safety through N+1 pump design
- Best fit for extreme liquid load per rack, or high in 2-3 racks

### SPECIFICATIONS

**General Data**
- Pump redundancy: 3 pumps for n+1 redundancy
- Power requirement: 100V – 240V 50/60 Hz
- Current consumption 2.47 – 4.44A
- Power supply 2, N+1, 2500W each
- Current consumption 10 - 15A
- Power supply 2, N+1, 1250W each
- Cooling capacity: 100 kW at 6 C Approach (100 LPM Primary)
- Minimum approach temperature: 4K
- Secondary coolant supply range ASHRAE W17 to W45 (previous W1 to W4)
- Power consumption: 820W (default mode), 1134W (max performance mode)
- Liquid Temp Range: 10 - 70 C (50 - 158 F)

**Primary Rating**
- Liquid Temp Range: 10 - 70 C (50 - 158 F)
- System Volume: 9.5 L (2.5 Gal)
- Maximum Flow (pumps): 60 LPM (16 GPM) at 0.4 bar (6 psi)
- Maximum Flow (triple pumps): 75 LPM (20 GPM) at 0.4 bar (6 psi)
- Maximum System Pressure: 1.4 Bar (20 psi) - Secondary by-pass opens at 20 psi, over pressure valve opens at 30 psi
- System Volume: 9.5 L (2.5 Gal)

**Secondary Performance**
- System Volume: 15.6 L (4.1 Gal)
- Maximum Flow (single pump): 115 LPM (30 GPM) at 0.5 bar (7 psi)
- Maximum Flow (dual pumps): 130 LPM (34 GPM) at 0.5 bar (7 psi)
- Maximum System Pressure: 3.4 Bar (50 psi)
- System Volume: 15.6 L (4.1 Gal)

**General Data**
- Pump redundancy: 2 pumps for n+1 redundancy
- Power requirement: 100V – 240V 50/60 Hz
- Current consumption 10 - 15A
- Power supply 2, N+1, 1250W each
- Cooling capacity: 100 kW at 6 C Approach (100 LPM Primary)
- Minimum approach temperature: 4K
- Secondary coolant supply range ASHRAE W17 to W45 (previous W1 to W4)
- Power consumption: 820W (default mode), 1134W (max performance mode)
- Liquid Temp Range: 10 - 70 C (50 - 158 F)

**Primary Rating**
- Liquid Temp Range: 10 - 70 C (50 - 158 F)
- System Volume: 15.6 L (4.1 Gal)
- Maximum Flow (dual pumps): 60 LPM (16 GPM) at 0.4 bar (6 psi)
- Maximum Flow (triple pumps): 75 LPM (20 GPM) at 0.4 bar (6 psi)
- Maximum System Pressure: 1.4 Bar (20 psi) - Secondary by-pass opens at 20 psi, over pressure valve opens at 30 psi
- System Volume: 9.5 L (2.5 Gal)

**Secondary Performance**
- System Volume: 15.6 L (4.1 Gal)
- Maximum Flow (single pump): 115 LPM (30 GPM) at 0.5 bar (7 psi)
- Maximum Flow (dual pumps): 130 LPM (34 GPM) at 0.5 bar (7 psi)
- Maximum System Pressure: 3.4 Bar (50 psi)
- System Volume: 15.6 L (4.1 Gal)
High Performance Row CDU

RackChiller CDU800
The nVent HOFFMAN RackChiller CDU800 is designed for efficient and safe supply of IT equipment. The entire system is focused on providing the highest reliability, availability, and serviceability for supporting direct-to-chip liquid cooling. The CDU800 is fed from a primary facility water system (FWS), where the integrated pumps drive the secondary technology cooling system (TCS) cooling loop flow. The heat exchanger transfers the excess heat from the secondary coolant to the primary. The complete system is integrated into an aesthetically enclosure with removable side panels and doors. The CDU can be installed onto a slab or raised floor, in-row with equipment racks or into a separate facility room.

Features
• Redundant high-performance, leak-free pump system
• Integrated variable speed drives
• Coolant connections through top or bottom panel
• Integrated 10-inch touch panel display
• Remote control features through Ethernet, SNMP v3, Mod bus
• On-board integrated leak detection
• 800 kW of performance at 6 K approach temperature difference (balanced flow) or 4 K (increased primary flow)
• Built in primary side 3-way valve with bypass shut valve – can operate as 2-way valve
• Dew point tracking and control of secondary supply temperature above condensing conditions

Benefits
• Enable waste heat reusage or high temperature primary circuit for maximum cooling efficiency
• Minimize amount of row CDUs required for high load installations – optimize floor space requirements
• Systems layout and design reduces need for redundant CDUs
• Minimum planning effort
• Reduced set up and installation time

Watch the video to learn more about CDU800

The RackChiller CDU800 offers one of the highest performance densities in a standard rack footprint

RackChiller CDU800 Technical Specifications

SPECIFICATIONS
General Data
• 800 kW of cooling capacity @ 6 K (850 LPM Primary)
• Pipe Connection: 3-inch ID hygienic tri-clamp
• Liquid Temp Range: 20 - 70 C (68 - 158 F)

Primary Rating
• Coolant: treated water with up to 20% PG
• Maximum Allowable Flow Rate: 1200 LPM (317 GPM)
• Maximum Head Loss (at 850 LPM, Water): 1.3 Bar (19 psi)
• Maximum System Pressure: 10.3 Bar (150 psi)
• System Volume: 50 L (13 Gal)
• Primary Filter Size: 250 micron

Secondary Performance
• Coolant: treated water with up to 30% PG
• Maximum Flow (single pump): up to 1100 LPM (290 GPM) at 2.6 bar (38 psi)
• Maximum Flow (dual pumps): up to 1100 LPM (290 GPM) at 3.4 bar (49 psi)
• Maximum Allowable Static Pressure: 3.5 Bar (50psi)
• Maximum System Pressure: 8.6 Bar (125 psi)
• Pressure Relief Valve Activation Pressure: 9.0 Bar (130 psi)
• System Volume: 100 L (26 Gal)
• Secondary Filter Size: 50 micron

INDUSTRY STANDARDS
UL/cUL Listed; File No. SA7402
CE

Standard Product

Catalog Number Description Height Width Depth Voltage Rating (V) Phase Rated Frequency (Hz) Rated Current (A) Power Consumption (kW) Noise (dB) Weight Dry (lb./kg) Weight Package (lb./kg)
CDU8004L002 850-480V 3-Phase Primary Filtration 2700 800 800 480 3 50/60 47.5 22.2 68 2500 1134 2820
CDU8004L102 850-480V 3-Phase Primary Filtration 2700 800 800 480 3 50/60 47.5 22.2 68 2500 1134 2820

CDU8004L002 850-480V 3-Phase Primary Filtration
CDU8004L102 850-480V 3-Phase Primary Filtration

Troubleshooting Guide

1. Check the power supply and fuses.
2. Ensure the control panel is powered on.
3. Verify the coolant connections are secured and leak-free.
4. Check the system pressure readings are within specifications.

Visit the nVent HOFFMAN website for more information and resources.
### Liquid Cooling Classifications For Data Centers

ASHRAE TC 9.9 defines different liquid cooling classifications for Data Centers based on facility water temperature available for cooling. The colder facility water would require higher upfront capital for the required cooling in terms of equipment and operating cost of chiller, cooling tower etc.

The warmer facility water would help alleviate the concerns of upfront capital on primary side cooling but it leads to other important factors to consider such as IT equipment max. temperature and also the approach temperature you have to live with. If approach temperature is constant, and the IT equipment can run at elevated temperatures, then CDU thermal capacity remains the same across the DC facility water temperature range.

**Thermal Capacity vs. Primary Inlet Temp**

<table>
<thead>
<tr>
<th>Primary Inlet Temp (°C)</th>
<th>Thermal Capacity (KW)</th>
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<tbody>
<tr>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>10</td>
<td>20</td>
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<tr>
<td>40</td>
<td>80</td>
</tr>
<tr>
<td>50</td>
<td>100</td>
</tr>
<tr>
<td>60</td>
<td>120</td>
</tr>
</tbody>
</table>

W1, facility water-W1 supply temperature of 2 °C to 17 °C

W2, facility water-supply temperature of 2 °C to 27 °C (Uses W1 and W2 typically apply to a data center that is traditionally cooled using chillers and a cooling tower but with an optional waterside economizer to improve energy efficiency depending on the location of the data center.

W3, facility water-supply temperature of 2 °C to 32 °C. For most locations, these data centers may be operated without chillers in a waterside economizer mode. Some locations may still require chillers to meet facility water supply temperature guidelines during peak ambient conditions for relatively short periods of time.

W4, facility water-supply temperature of 2 °C to 45 °C. To take advantage of energy efficiency and reduce capital expense, these data centers are operated in a waterside economizer mode without chillers. Heat rejection to the atmosphere can be accomplished by either a cooling tower or a dry (closed-loop liquid-to-air) cooler.

W5, facility water-supply temperature greater than 45 °C. W5 facilities take advantage of energy efficiency, reducing capital and operational expense with chillierless operation, and by making use of the waste energy. The facility water temperature is high enough to make use of the water exiting the IT equipment for heating local buildings.

### Exceptional Efficiency Performance

#### Hybrid Liquid Cooling Combining Liquid and Air Cooling

RackChiller Rear Door Cooler is combined with a rack mounted Direct Contact Liquid Coolant Distribution Unit (rCDU) to achieve new levels of rack-level cooling efficiency.

- Server cabinet
- RackChiller Rear Door chilled water heat exchanger
- Rack mounted Coolant Distribution Manifold (CDM)
- Rack Coolant Distribution Unit (rCDU)
- Integrated liquid pathway
- Sophisticated, coordinated controls, integrated monitoring system (Webserver, Modbus, SNMP) and local display

#### Benefits

- Reduces energy consumption
- Enables higher rack density
- Decreases total cost of ownership
- Quick and easy installation
- Modular design for easy future upgrades
- Ideal for Edge Computing applications

#### Features

- Designed to remove 100% of the heat generated in IT racks configured with high density heat loads
- Combines the extreme heat removal of Direct Contact Liquid Cooling at the chip level with a Rear Door air-to-water heat exchanger for residual heat removal
- Uses a single facility water line
- Sophisticated, coordinated controls
- Warm water exiting the RackChiller Rear Door Cooler complements the input requirements of the Rack Coolant Distribution Unit
- High temperature return water increases efficiency and can be used for heat re-use

### Table

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Unit</th>
<th>Operating Point 1</th>
<th>Operating Point 2</th>
<th>Operating Point 3</th>
<th>Operating Point 4</th>
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<tr>
<td>Server return water temp.</td>
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<td>rCDU approach temp. diff.</td>
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<td>63.6</td>
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<tr>
<td>Percentage air-cooled</td>
<td>%</td>
<td>25</td>
<td>20</td>
<td>17</td>
<td>14</td>
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<tr>
<td>Percentage liquid-cooled</td>
<td>%</td>
<td>75</td>
<td>80</td>
<td>83</td>
<td>86</td>
</tr>
</tbody>
</table>

### ASHRAE TC 9.9 Overview

#### Liquid Cooling Capabilities

ASHRAE TC 9.9 provides a detailed overview of liquid cooling guidelines for Datacom Equipment Centers. It categorizes liquid cooling based on the facility water temperature available for cooling. Different classes (W1 to W5) are defined, each with specific temperature ranges and operational considerations.

- **W1**: Facility water supply temperature of 2 °C to 17 °C
- **W2**: Facility water supply temperature of 2 °C to 27 °C
- **W3**: Facility water supply temperature of 2 °C to 32 °C
- **W4**: Facility water supply temperature of 2 °C to 45 °C
- **W5**: Facility water supply temperature greater than 45 °C

These classifications help determine the appropriate liquid cooling solutions based on the facility’s water temperature, operational costs, and energy efficiency considerations. The guidelines also emphasize the importance of energy efficiency and the role of open-loop systems in achieving these goals.

### ASHRAE "Liquid Cooling Guidelines for Datacom Equipment Centers Second Edition, Datacom Series 4"

This reference document provides comprehensive guidelines for liquid cooling in Datacom Equipment Centers, focusing on energy efficiency, operational costs, and the integration of cooling solutions with existing infrastructure.

- **Thermal Capacity vs. Primary Inlet Temp**
  - Moving from a room or row based cooling to a rack or direct-to-chip based cooling solution allows to increase the water-supply temperature.

- **Benefits**
  - Reduces energy consumption
  - Enables higher rack density
  - Decreases total cost of ownership
  - Quick and easy installation
  - Modular design for easy future upgrades
  - Ideal for Edge Computing applications

- **Features**
  - High temperature return water increases efficiency and can be used for heat re-use

### W3, W4, W5 Classifications

- **W3**: Facility water-supply temperature of 2 °C to 32 °C
- **W4**: Facility water-supply temperature of 2 °C to 45 °C
- **W5**: Facility water-supply temperature greater than 45 °C

These classifications are designed to optimize energy efficiency and minimize capital expenses by utilizing warmer facility water temperatures, which can reduce the need for cooling equipment.

### Exceptions

- **W1**: Facility water supply temperature of 2 °C to 17 °C
- **W5**: Facility water supply temperature greater than 45 °C

Special considerations apply when operating within these temperature ranges, including the potential for increased heat rejection to the atmosphere and the need for more advanced cooling technologies.
Leak Detection And Heat Tracing Solutions

Avoid Major Problems With Water Leak Detection

Water leaks from burst pipes, indoor plumbing, faulty appliances, or even the weather can damage property, data, and customer goodwill. That’s why building owners invest in smart water leak detection equipment in offices, hotels, museums, computer rooms, data centers, or other industrial and commercial buildings. nVent RAYCHEM TraceTek water leak detection systems detect, locate and communicate small leaks before major problems develop. Whether it’s protecting datacenters with expensive electronics or protecting vital pipe infrastructure, our solutions are modular and tailored to your specific needs, to provide reliable and dependable protection for many years.

Benefits

• Long term reliable systems made with high performance polymers for maximum durability.
• Cables and probes that directly detect and accurately pinpoint the source of the leak.
• Digital communications powered independently of the sensor cable so that damage to the sensor cable does not cripple the entire system.
• A robust digital backbone that gives the ability to independently track many leaks at once, with local, networked or remote alarms and diagnostics.
• Flexible design options that permit sensor cables to be short or long and deployed on one floor or many levels of the building while being centrally monitored from the most effective locations.
• Graphic mapping that shows the location of any detected leak on a background graphic of your choosing that flashes an icon in the exact location of the detected leak.
• Optional fuel sensors to monitor the back-up emergency generators and associated diesel fuel tanks, pipes and fittings (FM7745 compliant).
• Multiple digital communications protocols and integration to building management systems, email / SMS or web page.
• Configuration options that automatically shut off pumps or valves where appropriate.
• Modular assemblies that can be configured for current needs and allow for future expansion of your leak detection system.
• Ability to monitor up to 250 cables independently of each other.

Leak Detection

<table>
<thead>
<tr>
<th>Product Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>TTDM-128</td>
<td>Single channel and network master panel monitor</td>
</tr>
<tr>
<td>TTFS92-PANEL</td>
<td>12” touch screen monitoring panel and network master</td>
</tr>
<tr>
<td>TT5IM-1A</td>
<td>Modbus enabled sensor interface module with relay</td>
</tr>
<tr>
<td>TT1000</td>
<td>Modular water sensing cable</td>
</tr>
<tr>
<td>TT1100-CHP</td>
<td>Water sensing cable for use with suspended water piping</td>
</tr>
<tr>
<td>TTFLAT-PROBE</td>
<td>Water and conductive liquids detector, flat probe</td>
</tr>
<tr>
<td>TT4NIN-PROBE</td>
<td>Water and conductive-liquids sensing probe with metal connector</td>
</tr>
<tr>
<td>TTMLC-PC</td>
<td>Modular leader cable with female connector on one side and pigtail lead on other side</td>
</tr>
<tr>
<td>TTMET-PC</td>
<td>Modular and termination with plastic connector</td>
</tr>
<tr>
<td>TTMB-CPC</td>
<td>Modular branch connector with plastic connector</td>
</tr>
<tr>
<td>TTJUC-PC</td>
<td>Modular jumper cable with factory installed plastic connectors</td>
</tr>
<tr>
<td>TT5000-MC</td>
<td>Modular liquid fuels sensing cable with factory installed connectors</td>
</tr>
<tr>
<td>TTFFS-WR</td>
<td>TT-FFS-WR series fuel probe</td>
</tr>
</tbody>
</table>

Configure To Your Needs

Leak Detection Configured To Your Needs

Critical infrastructure and equipment typically requires both 24/7 availability and absolutely no damage. Our water leak detection systems consist of sensor cables, probes and monitoring systems, to detect and pinpoint leaks, allowing you to take action immediately and at the right location. TraceTek technologies include sensor cables, fast acting probes, monitoring and alarm panels. These modular units can be configured to suit simple or complex applications and allow for future expansion. The capability to integrate in building information management systems, provides central visibility over the entire system. TraceTek leak detection systems are simple to operate, rugged in design and reliable in use.

Heating Cable Solutions

Specialized nVent RAYCHEM self-regulating heating cables, controllers, and accessories are ideal for pipe freeze protection, roof and gutter de-icing, and fuel oil temperature maintenance. These will help you protect your facility while complying with today’s building regulations on energy savings. A complete nVent RAYCHEM system can result in energy savings of up to 80%! Additionally, nVent RAYCHEM connection systems are designed and configured to be fully compatible with our heating cables and decreases installation time by up to 80%.

Heat Tracing System Design Tools

TraceCalc Pro For Buildings is an intuitive, easy-to-use, online design tool that lets you create simple or complex heat-tracing solutions. Additional BIM, MasterSpec and CAD Details tools are available at our Designer’s tool box.

Online Design Tool


Protect your Data Center’s pipes, roofs, and gutters from freezing water, ice and snow.
Thermal Simulation

Computational Fluid Dynamics (CFD) can be used to analyze existing or future data center thermal capacity, installed IT equipment load and data center infrastructure performance. CFD analysis supports the optimization of existing or future IT equipment layouts. Virtual recording and tests maintain educated decisions on operational infrastructures to check fallout plans, redundancies, position of sensors and cooling components as well as capacity planning.

ADVANTAGES OF CFD
• Minimize planning outlay
• Reduce operational cost
• Improve existing infrastructure
• Asset planning

Application
In the previous 5 years, the performance of servers, storage, and networking equipment has increased exponentially. Along with this performance growth has come a significant increase in the power dissipated by the server, storage, and networking hardware. This has caused a significant strain on the data center infrastructure that was built for hardware power levels much less than what is being delivered today. Placement of IT equipment, air handlers, close-coupled cooling, and direct liquid cooling technologies within the data center environment is critical to the efficient use of available space and data center cooling capacity. Lead time for facility upgrades and capital planning requirements mandate comprehensive planning.

Evaluation Completed By Expert nVent Engineers
A key to the effective deployment of IT equipment is an evaluation of the current and future thermal profile of the data center. nVent thermal analysis enables customers to choose the most efficient and effective cooling technologies and layouts for their specific IT hardware by modelling the necessary infrastructure modifications or layout changes.

Typical Project Tasks:
• Project scope/resources/schedule agreed upon
• On-site evaluation and consultation
• Analyze and optimize with CFD models
• Final meeting with evaluation report and recommendations for data center layout

Support And Services
Whatever challenges you have to overcome, we will work together to find the perfect solution. Standard off the shelf, preconfigured products or a custom solution, our products are the result of our experts know-how in cabinets and racks integrating mechanics, electronics and thermal management. Wherever you are: trust in nVent with the widest range of application requirements. With our pre- and post-sales services we support you over the full product life cycle.

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PROFESSIONAL SERVICES
With a network of qualified field installation and repair technicians around the world, nVent offers unparalleled cooling support and services to quickly restore your system. Depend on us for local customer service, regional spare parts inventories and competitive standard warranties. Extended warranties and preventive maintenance are also available.
Our powerful portfolio of brands:

CADDY  ERICO  HOFFMAN  RAYCHEM  SCHROFF  TRACER